

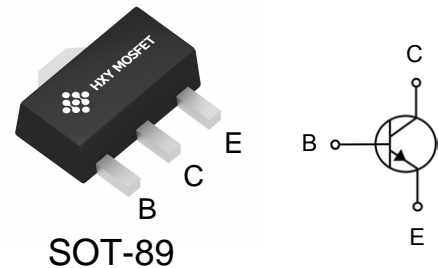


## Features

- Collector Current:  $I_C = 1A$
- Power Dissipation of 500mW

## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
BCX54-16,115	SOT-89	BCX54-16	1000



## Maximum Ratings ( $T_a=25^{\circ}C$ unless otherwise noted)

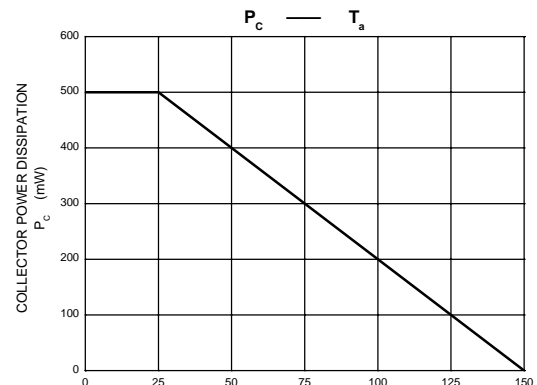
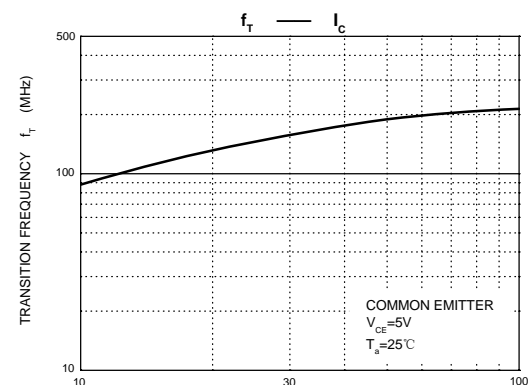
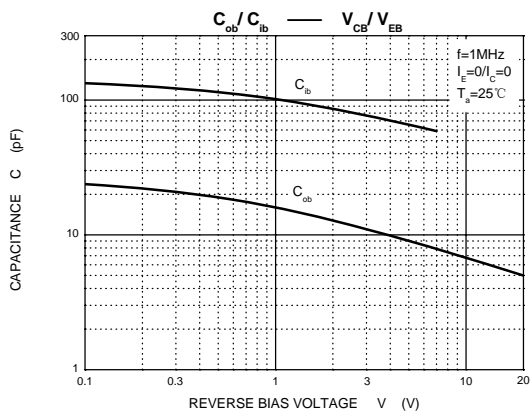
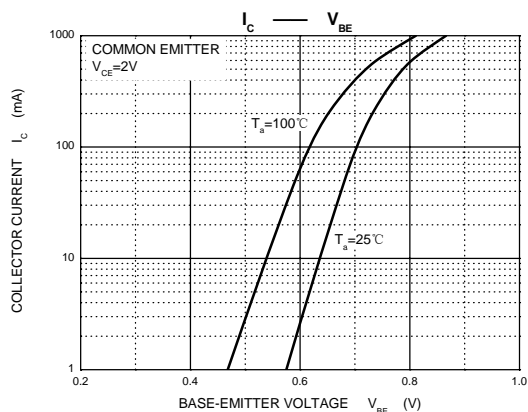
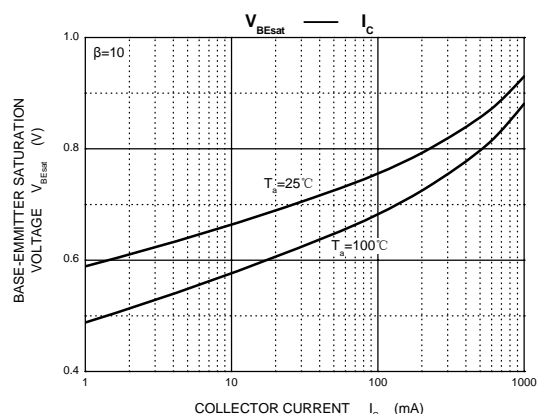
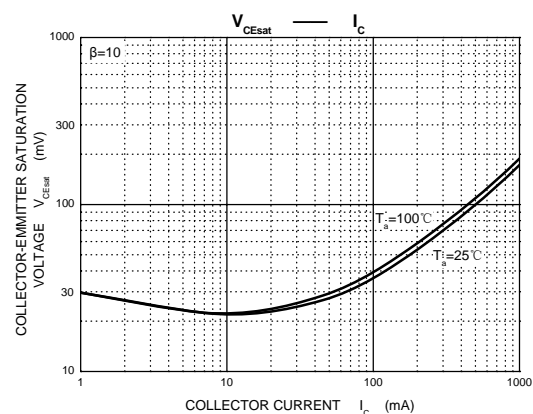
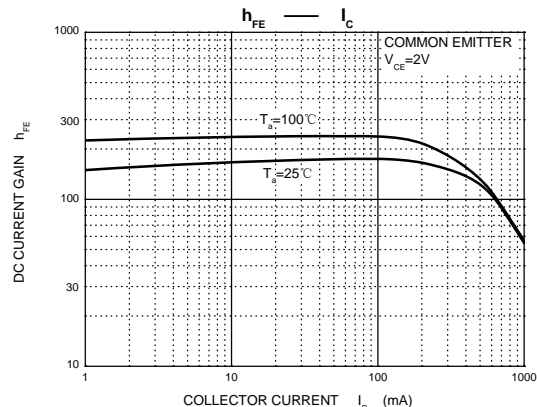
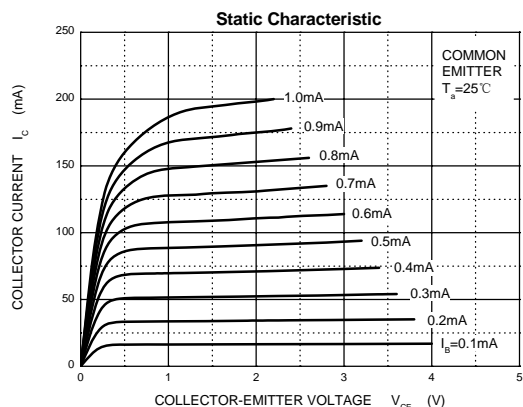
Symbol	Parameter	Value	Unit
$V_{CBO}$	Collector-Base Voltage	45	V
$V_{CEO}$	Collector-Emitter Voltage	45	V
$V_{EBO}$	Emitter-Base Voltage	5	V
$I_C$	Collector Current-Continuous	1	A
$P_C$	Collector Power Dissipation	500	mW
$T_j$	Junction Temperature	150	$^{\circ}C$
$T_{stg}$	Storage Temperature	-55-150	$^{\circ}C$

## Electrical Characteristics ( $T_a=25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=100\mu A, I_E=0$	45			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}^*$	$I_C=10mA, I_B=0$	45			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=10\mu A, I_C=0$	5			V
Collector cut-off current	$I_{CBO}$	$V_{CB}=30V, I_E=0$			0.1	$\mu A$
Emitter cut-off current	$I_{EBO}$	$V_{EB}=5V, I_C=0$			0.1	$\mu A$
DC current gain	$h_{FE(1)}^*$	$V_{CE}=2V, I_C=5mA$	40			
	$h_{FE(2)}^*$	$V_{CE}=2V, I_C=150mA$	100		250	
	$h_{FE(3)}^*$	$V_{CE}=2V, I_C=0.5A$	25			
Collector-emitter saturation voltage	$V_{CE(sat)}^*$	$I_C=0.5A, I_B=50mA$			0.5	V
Base-emitter voltage	$V_{BE}^*$	$V_{CE}=2V, I_C=0.5A$			1	V
Transition frequency	$f_T$	$V_{CE}=5V, I_C=10mA, f=100MHz$		130		MHz

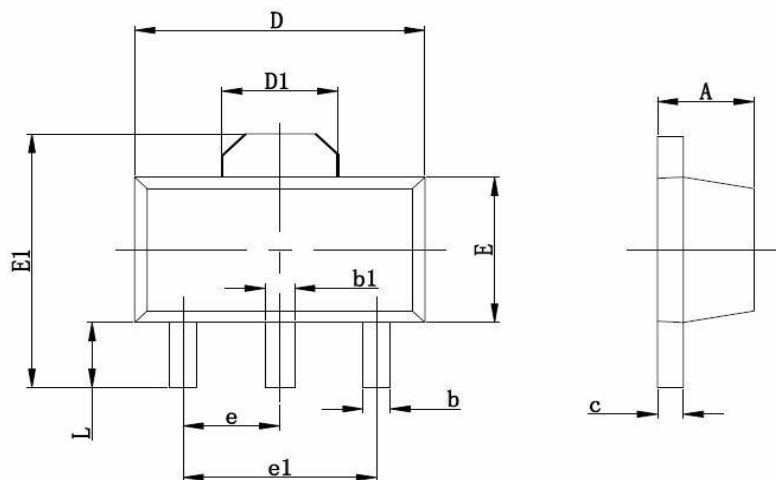


## Typical Characteristics





## SOT-89 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.400	1.600	0.055	0.063
b	0.320	0.520	0.013	0.020
b1	0.400	0.580	0.016	0.023
c	0.350	0.440	0.014	0.017
D	4.400	4.600	0.173	0.181
D1	1.550 REF.		0.061 REF.	
E	2.300	2.600	0.091	0.102
E1	3.940	4.250	0.155	0.167
e	1.500 TYP.		0.060 TYP.	
e1	3.000 TYP.		0.118 TYP.	
L	0.900	1.200	0.035	0.047



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